

# Deep-ultraviolet photodetector based on exfoliated n-type $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanobelt/p-Si substrate heterojunction

Gahyun Shin\*,\*\*, Hong-Yeol Kim\*\*, and Jihyun Kim\*,\*\*,†

\*Department of Nano-photonics Engineering, Korea University, Seoul 02841, Korea

\*\*Department of Chemical and Biological Engineering, Korea University, Seoul 02841, Korea

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**Abstract**—Low-dimensional semiconductor p-n junctions as components for optoelectronic devices are considered to be more promising than thin film equivalents. We fabricated heterojunction p-n solar blind photodiodes with the configuration of n-type  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanobelts contacted onto p-Si substrates. The junction between  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and Si was formed by van der Waals interactions. The fabricated heterojunction p-n diodes exhibited typical rectifying current-voltage characteristics, with a rectification ratio as high as  $1.56 \times 10^4$  at  $\pm 20$  V and an ideality factor of approximately eight. Photoresponsive measurements showed that the heterojunction p-n diodes had a high sensitivity and selectivity for light at a wavelength of 254 nm, with fast response and decay characteristics. For the fast-response components, the response time constant was 4.06 s and the decay time constant was 0.16 s. The exfoliated  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanobelt/Si p-n heterojunction presented here constitutes a functional unit for low-dimensional ultra-wide bandgap electronic and optoelectronic devices.

Keywords:  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>, Nanobelt, Solar-blind Photodiode, p-n Heterojunction, van der Waals Interaction

## INTRODUCTION

$\beta$ -Ga<sub>2</sub>O<sub>3</sub> has attracted considerable attention as a next-generation high-power semiconductor material because of its ultra-wide energy bandgap of ~4.9 eV (direct) [1,2]. It is chemically and physically stable and its optical transparency at visible to deep ultraviolet (UV) wavelengths makes it particularly applicable to solar blind photodetectors. Moreover,  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> can be grown with a single crystalline bulk substrate (monoclinic) [3]. Bulk  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> substrates fabricated by edge-defined film-fed growth (EFG) are commercially available in sizes up to 2" and plates with dimensions of 4" and 6" are in development. There has also been progress in epitaxial growth techniques, including metalorganic chemical vapor deposition, hydride vapor phase epitaxy, and molecular beam epitaxy with controlled n-type doping over the range  $10^{15}$ - $10^{19}$  cm<sup>-3</sup> using shallow donors (Sn or Si) [4]. With its numerous advantages,  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> is suitable for high-voltage power devices and UV optoelectronics. Higashiwaki et al. demonstrated  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>-based power devices by fabricating metal-semiconductor field-effect transistors and metal oxide-semiconductor field-effect transistors [3,5,6]. UV photodetectors and light-emitting diodes based on  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> with different structures have also been investigated [7-10].

Low-dimensional semiconductors have more attractive features than thin film semiconductors, such as improved crystallinity and quantum confinement effects [11-13]. Dislocation-free single crystal GaN nanowire LEDs were reported whereby the emission wavelength could be tuned from 365 to 600 nm.  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanostructures

such as nanowires [14], nanobelts [15-17], and nanosheets [18] have been synthesized. Interestingly,  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanostructures can also be obtained by mechanical exfoliation even though  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> only contains covalent bonds in its structure. There has not been a clear explanation yet, but it is commonly accepted that large differences in lattice constants allows  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> to be exfoliated to form nanostructures. An important advantage of mechanical exfoliation and transfer of low dimensional materials is the ease with which heterostructures can be formed with arbitrary substrates. Mechanical exfoliation also enables two or more materials to be stacked together through van der Waals interactions without lattice-induced strain. For example, Lee et al. demonstrated field-effect transistors by mechanically stacking graphene, hexagonal boron nitride (hBN), and molybdenum disulfide (MoS<sub>2</sub>) [19]. The van der Waals heterostructure commonly has an abrupt transition between the stacked materials and a sharp gradient of carrier concentrations across the interface [20].

In this study, we demonstrate a p-n heterojunction by stacking n-type  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanobelts over p-type Si because it is challenging to obtain p-type  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> due to the intrinsic oxygen vacancies. The optical and electrical properties of the fabricated p-n heterojunction diodes were systematically investigated, illustrating the high potential of  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>-based (opto)electronic devices.

## EXPERIMENTAL DETAILS

A schematic of the device fabrication process is shown in Fig. 1. SiO<sub>2</sub>/p<sup>++</sup>Si (300 nm/500  $\mu$ m) was partially covered with photoresist (PR) and immersed in a buffered oxide etchant (6 : 1 diluted HF, BOE, J.T. Baker) for 10 min at room temperature (Fig. 1(a)). The exposed SiO<sub>2</sub> was wet-etched to reveal the underlying p<sup>++</sup>Si, which

<sup>†</sup>To whom correspondence should be addressed.

E-mail: hyunhyun7@korea.ac.kr

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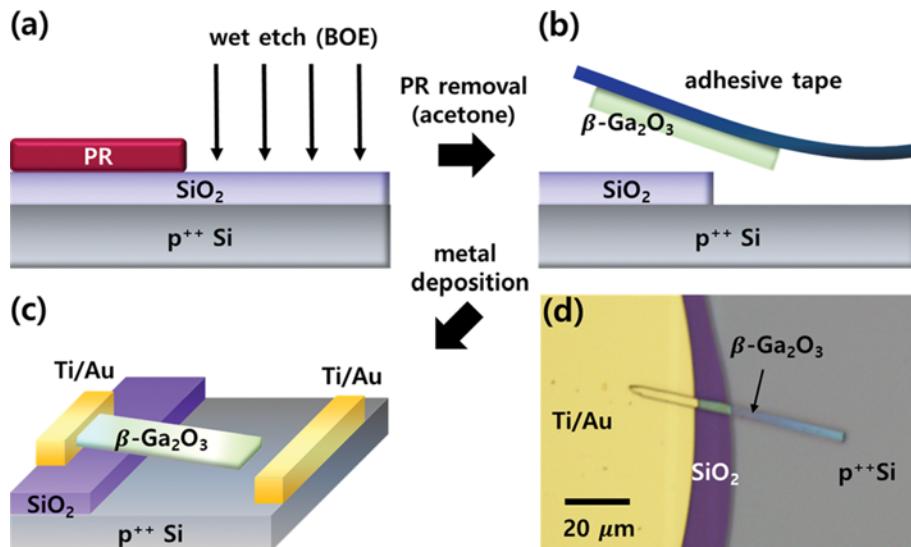


Fig. 1. (a)-(c) Schematic of device fabrication process, (d) optical microscope image of the fabricated p-n heterojunction diode.

was verified through sheet resistance measurements using a four-point probe (Desk 205, MS Tech) linked to a source meter (Keithley 2400). The microscale  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanobelts were mechanically exfoliated by using a commercial adhesive tape from the unintentionally n-doped bulk  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> single crystals (Tamura Corporation) grown by EFG. The mechanically exfoliated nanobelts were transferred onto the pre-patterned SiO<sub>2</sub>/p<sup>++</sup>Si (Fig. 1(b)). As shown in Fig. 1(c), one end of the deposited  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flake forms a p-n junction with the p<sup>++</sup>Si through van der Waals interactions, and the other end is isolated from the Si by the SiO<sub>2</sub> (300 nm thick). A conventional photolithography process and an electron beam evaporation technique were used to define Ti/Au contacts (100 nm/200 nm).

Fabrication of the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>/Si p-n heterojunction was confirmed using a combination of optical microscopy (Olympus, BX51M), field emission scanning electron microscopy (FE-SEM, Hitachi, S-4700), and electrical characterizations. Micro-Raman spectroscopy was conducted at room temperature in a back-scattering geometry with a 532 nm wavelength diode-pumped solid-state laser (Omicron) for analyzing the crystalline structure of the exfoliated  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flake. Transmission electron microscopy (TEM, JEOL, JEM-2100F) and selected area electron diffraction (SAED) were also used to investigate the crystal structure and quality of the exfoliated nanobelts, where the specimen was prepared by focused ion beam mill-

ing (FIB, Quanta2003D, FEI). An additional carbon layer was deposited above the specimen to protect the surface of the sample from Ga-ion bombardments during FIB milling. The current-voltage (I-V) characteristics and time-dependent photoresponses were measured using a semiconductor parameter analyzer (Agilent 4155C) connected to the probe station. The UV lamp (15 W, UV Itec LTD) used as the light source had emission wavelengths of 254 and 365 nm. The light intensity was measured by using a power meter (FieldMax II-TO, Coherent). A Hall effect measurement system (Ecopia, HMS-3000) was used to determine the carrier concentration of the p<sup>++</sup>Si substrate.

## RESULTS AND DISCUSSION

The optical microscope image in Fig. 1(d) shows that one end of the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flake lying on the SiO<sub>2</sub> is covered with Ti/Au and the opposite end contacts the p<sup>++</sup>Si substrate. The heterojunction structure was observed from several different viewpoints using FE-SEM. (Fig. 2(a)). The space between the transferred  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flake and Si becomes smaller and eventually they form a heterojunction at the end. The three phonon peaks below 200 cm<sup>-1</sup> are correlated to the low-frequency vibration and translation of tetrahedron-octahedron chains within the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> structure (Fig. 2(b)). The

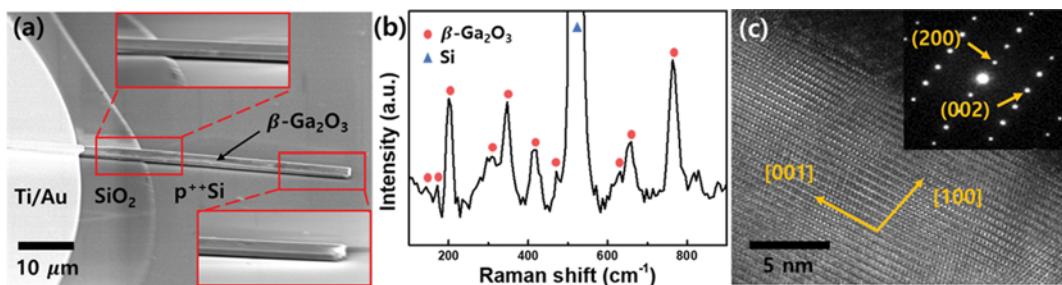


Fig. 2. (a) SEM images of the fabricated p-n  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>/Si heterojunction diode, (b) micro-Raman spectrum of the exfoliated  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flake, (c) TEM image and SAED pattern (inset) of the exfoliated  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flake.

phonon peaks between 300 and 500 cm<sup>-1</sup> are related to the mid-frequency deformation of Ga<sub>2</sub>O<sub>6</sub> octahedra, and the peaks between 600 and 800 cm<sup>-1</sup> are attributed to the high-frequency stretching and bending of GaO<sub>4</sub> tetrahedra (Fig. 2(b)) [21,22]. The peak positions in Fig. 2(b) are consistent with those reported in previous studies [21-23], which indicates that the quality of the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> flakes was maintained during mechanical exfoliation, transfer, and device fabrication. A high-resolution cross-sectional TEM image and SAED pattern of the transferred  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> nanobelts was obtained. The surface of the exfoliated flakes had a crystallographic orientation of (100). It has already been shown that the atomic arrangement of monoclinic  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> permits facile cleavage into thin flakes along the [100] direction, which has a larger lattice constant than the other primary directions ( $a[100]=12.225$  Å and  $b[010]=3.039$  Å,  $c[001]=5.801$  Å) [23,24]. Distances of 0.57 nm and 0.28 nm were calculated (inset of Fig. 2(c)) from the SAED pattern, corresponding to the distances between the (200) planes and (002) planes, respectively.

To investigate the electrical and optical properties of the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>/Si heterojunction p-n diodes, I-V measurements were conducted in both dark and light conditions (Fig. 3(a)). The diodes showed typical rectifying behavior. The asymmetric ratio ( $I_F/I_R$ ) under dark conditions was as high as  $1.56 \times 10^4$ , with the current ( $I_R$ ) at a reverse bias of -20 V and the current ( $I_F$ ) at a forward bias of +20 V. The ideality factor was estimated to be approximately eight, which is attributed to the large series resistance, non-optimized contacts, and residues at the interface. The currents under 365 nm wavelength were the same as those under dark conditions, suggesting that the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>/Si heterojunction does not respond to the 365 nm wave-

length (UV-A) (inset of Fig. 3(a)). However, it responded to the 254 nm wavelength (UV-C), indicating solar blindness of the fabricated p-n heterojunction.

The time-dependent photoresponses under 254 nm and 365 nm illuminations were also obtained at a forward bias of 30 V. The currents increased instantaneously from ~23 nA to ~55 nA during the exposure to 254 nm and decayed promptly to ~30 nA when the light source was off (Fig. 3(b)). However, no changes in the photocurrent were observed under illumination at 365 nm, which is different from other reported  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> photodetectors [7,8,25,26] that respond to the 365 nm wavelength to some extent. When deep-level defects are present, the wavelengths longer than the bandgap energy can be absorbed. The absence of photoresponse at the wavelength of 365 nm indicates high quality materials and a good junction between the n-type  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and p-type Si.

For the time-dependent photoresponses, the fast-response (rise and decay) component is generally attributed to a rapid change in the photo-generated carrier concentrations when the light is turned on and off. Whereas, the slow-response component is related to the carrier trapping/de-trapping mechanism resulting from deep-level defects [26,27]. For a more detailed study of response time, a quantitative analysis of the current rise and decay process was conducted. The photoresponse curve was fitted with a bi-exponential relaxation function

$$I = I_0 + Ae^{-t/\tau_1} + Be^{-t/\tau_2}$$

where  $I_0$  is the steady-state photocurrent,  $t$  is the time,  $A$  and  $B$  are constants, and  $\tau_1$  and  $\tau_2$  are two relaxation time constants. The photoresponse processes are well-fitted to the experimental data

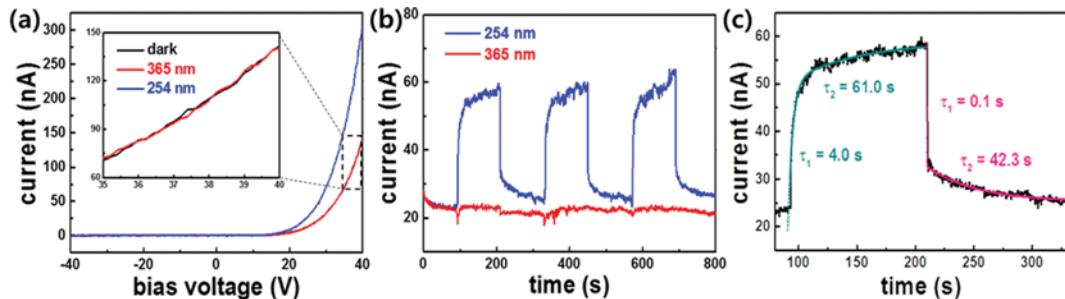


Fig. 3. Electrical and opto-optical properties of the fabricated p-n  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>/Si heterojunction diode showing (a) I-V characteristics, (b) time-dependent photoresponse, and (c) experimental and fitted curve of photoresponse to 254 nm illumination.

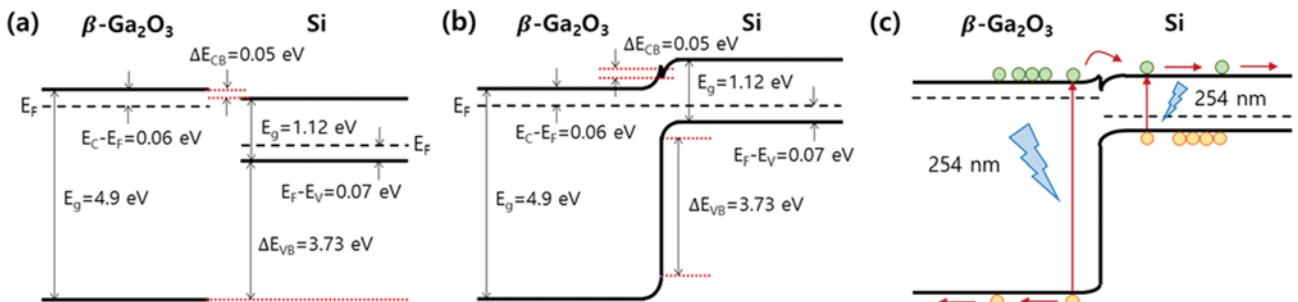


Fig. 4. Band diagrams of n-type  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and p<sup>+</sup> Si heterostructure showing (a) before junction formation, (b) after junction formation, and (c) under 254 nm illumination.

obtained under the illumination of 254 nm (Fig. 3(c)). Time relaxation constants under 254 nm exposure were 4.0 s ( $\tau_1$ ) and 61.0 s ( $\tau_2$ ), which are comparable to previous reports. The time relaxation constants for decay were 0.1 s ( $\tau_1$ ) and 42.3 s ( $\tau_2$ ), which can be attributed to the formation of the p-n heterojunction. The values of the conduction band offset ( $\Delta E_{CB}$ ) and valance band offset ( $\Delta E_{VB}$ ) were determined using Anderson's rule (Fig. 4) [29].  $\Delta E_{CB}$  was estimated to be 0.05 eV based on differences in electron affinities for  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and Si, which were 4.0 eV and 4.05 eV, respectively. The  $\Delta E_{VB}$  value was determined to be 3.73 eV based on the bandgap values of  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and Si, which were 4.9 eV and 1.12 eV, respectively. Chen et al. used X-ray photoelectron spectroscopy to measure the valance and conduction band offsets for  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and Si [30], and the values were similar to those reported here. The  $E_F-E_C$  value of  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> was estimated to be 0.06 eV, which is consistent with literature [31,32]. In the same way, the  $E_F-E_V$  value of Si is calculated to be 0.07 eV with a hole carrier concentration of  $7.59 \times 10^{17} \text{ cm}^{-3}$ , measured by the Hall effect method. Considering all the values, the band diagrams of  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> and Si before and after junction formation are shown in Fig. 4(a) and (b), respectively. Type-II band alignment is assumed at the interface of the  $\beta$ -Ga<sub>2</sub>O<sub>3</sub>/Si heterojunction (Fig. 4(b)). The electron-hole pairs excited by 254 nm wavelength contributed to the photocurrent (Fig. 4(c)), demonstrating the p-n heterojunction solar-blind photodetectors.

## CONCLUSION

Heterojunction p-n diodes with high rectification ratio, high spectral selectivity, and fast photoresponse were fabricated using n-type  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> micro-flake and p-type Si substrate. The micro-flakes mechanically exfoliated from single crystal  $\beta$ -Ga<sub>2</sub>O<sub>3</sub> were transferred onto the p-Si substrate, forming a p-n junction by van der Waals interactions. The p-n heterojunction exhibited typical rectifying characteristics with a high rectification ratio of  $1.56 \times 10^4$ . A fast photo response to a wavelength of 254 nm (UV-C) was observed with no persistent photo conductance. Ga<sub>2</sub>O<sub>3</sub>-based optoelectronic devices can open up the possibility for next-generation solar-blind photodetectors.

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